

System Thermal Test Report

Model: View 600 TG

Version: **20250818A**

NO: RS202508180001





- A. Introduction
- **B.** Test Configuration
 - C. Conclusion



A. Introduction

- 1. Objective
- 2. Equipment
- 3. Procedure









Our objective is to find out if the **View 600 TG** can efficiently extract the heat generated by the latest components, so we built a system with an Intel Core Ultra 9 285K and a ASUS ROG Strix GeForce RTX® 5090 OC and put it to the test. The passing criteria we set was to keep the internal temperature under **47°C** while the system is running at full load, with **ten** installed fans and a AIO **420** installed.



2. Equipment

The equipment we used in the thermal testing includes:

- 1. Temperature & Humidity Chamber
- 2. Data Acquisition Device
- 3. Thermocouple

The Temp. & Humidity Chamber ensures consistency in the testing environment, particularly temperature and humidity. The **temperature** was set at **25°C** and the **humidity** at **50%** in the chamber.

The Data Acquisition Device helps us to directly collect the data through **thermocouples**, which is the most important equipment for our testing. We set up the thermocouple inside the case at various points to measure the temperature.

We used **AIDA64 Extreme** and **FurMark ROG Edition** to push 100% load on the CPU and GPU and tested for 30 minutes.



3. Procedure

Testing steps:

- 1. Ready the systems
- 2. Place the chassis into the Temp. & Humidity Chamber
- 3. Set the thermocouple at the specified places
- 4. Set up the Temp. & Humidity Chamber temperature at 25 °C and the humidity at 50%
- 5. Turn on the Temp. & Humidity Chamber and start testing (for 30 minutes)
- 6. Check the data acquired from the Data Acquisition device
- 7. End testing

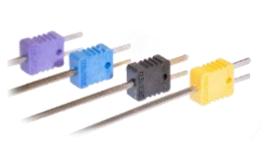


B. Test Configuration

- 1. Laboratory Equipment
- 2. Chassis Hardware List
- 3. Chassis Fan Allocation
- 4. Chassis Thermal Airflow
- 5. Chassis Measured Points
 - 6. Thermal Stress Test
- 7. AIDA64 & FurMark Test
- 8. Graphics Performance Testing
 - 9. Acoustic Test



1. Laboratory Equipment





Thermocouple

Sound Level Meter



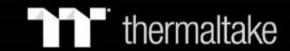


Thermal Imaging Camera

Temperature Data Acquisition



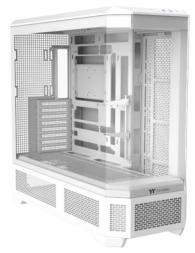
Temperature & Humidity Chamber



2. Chassis Hardware List

Component	Model
Chassis	View 600 TG Snow
Motherboard	ASUS ROG Maximus Z890 Hero
CPU	Intel® Core™ Ultra9-285K Processor (TDP 250W)
GPU	ASUS ROG Strix GeForce RTX® 5090 OC 32GB GDDR7
RAM	TOUGHRAM XG RGB D5(16G x 2)
SSD	Seagate SSD 120G
PSU	Toughpower GF3 Snow 1200W
CPU Cooler	MAGFloe 420 Ultra ARGB Sync Snow Edition
Fans	AIO: SWAFAN EX14 ARGB x 3 (2000 rpm) Chassis: TOUGHFAN EX 140 ARGB x 7 (2000 rpm) (Top x 3 , Rear x 1, Power Cover x 3)
Software	 AIDA64 Extreme FurMark ROG Edition V0.9.3.0 CPU-Z Ver.2.015 x64 Core Temp V1.18.1
Full load	30 minutes
Camera	Testo 885-2 Thermal Imaging Camera



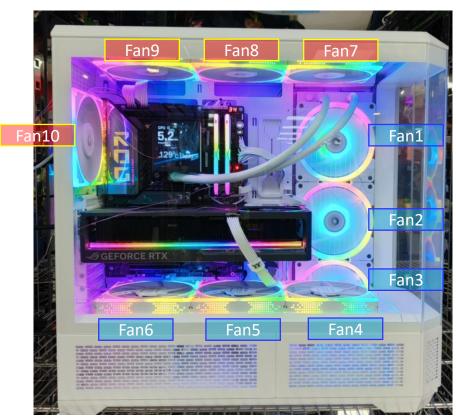






3. Chassis Fan Allocation

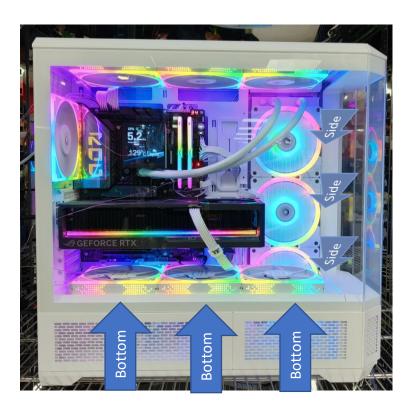






4. Chassis Thermal Airflow

Cool Airflow Inlets (Active)

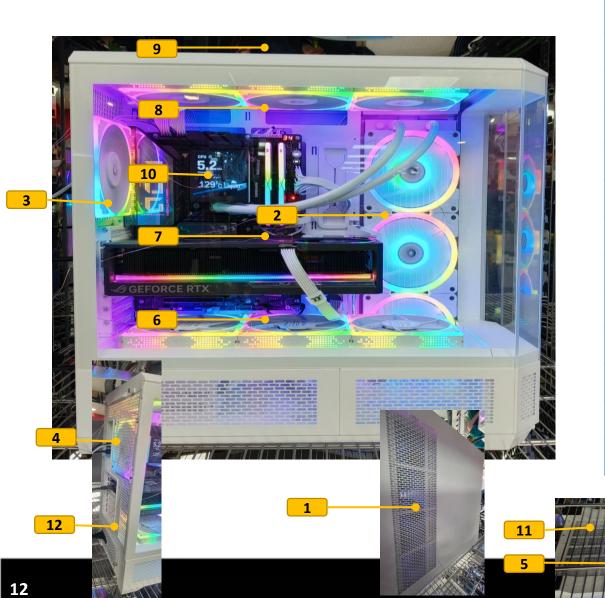


Hot Airflow Exhausts





5. Chassis Measured Points



Measure Point	Description	Airflow	Thermocouple Number
1	Chassis Right Internal	Intake	101
2	Chassis Right Exhaust	Intake	102
3	Chassis Rear Internal	Exhaust	103
4	Chassis Rear Exhaust	Exhaust	104
5	Chassis Bottom Exhaust	Intake	105
6	Chassis Bottom Internal	Intake	106
7	GPU Right Fan	Exhaust	107
8	Chassis Top Internal	Exhaust	108
9	Chassis Top Exhaust	Exhaust	109
10	AIO Top Cover	Nature	110
11	PSU Bottom	Intake	111
12	PSU Rear	Exhaust	112

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6. Thermal Stress Test



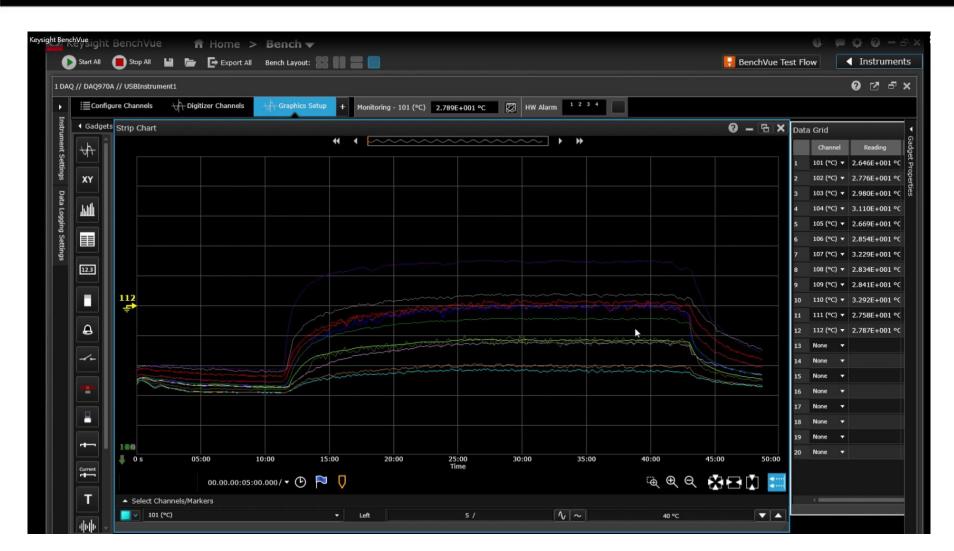




- Setting up the chamber temperature and humidity
- Temperature: 25°C
- Humidity: 50%
- Recording Data



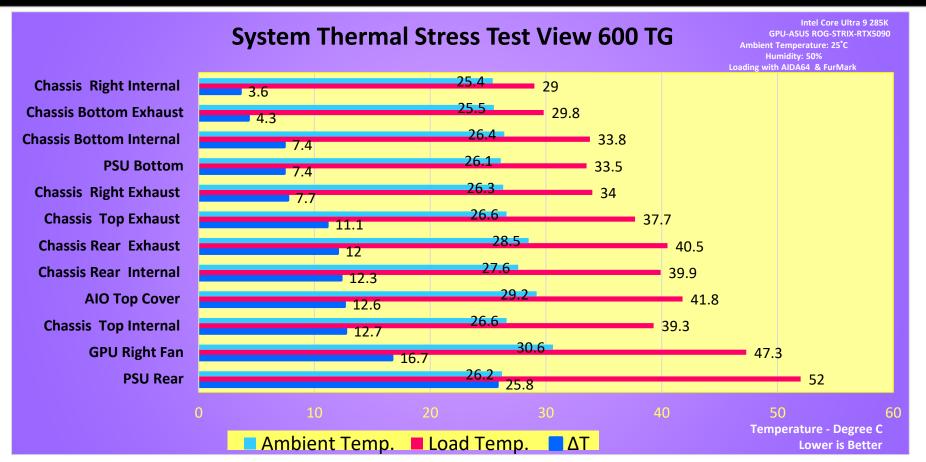
6. Thermal Stress Test



Temperature Data Recoding



6. Thermal Stress Test

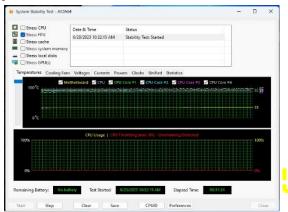


We expected to see higher temperature at the exhaust points and relatively lower temperature at the intake positions. The highest temperature was found at the AIO exhaust, which is reasonable given the CPU was running at full load. Most of the intake positions recorded a temperature lower than 47°C since they were drawing air from environment. Two critical positions we were looking at are NO. 107 GPU Right Fan and NO. 110 AIO Cover, which were drawing internal air to cool two of the most important components.



7. AIDA64 & FurMark Test

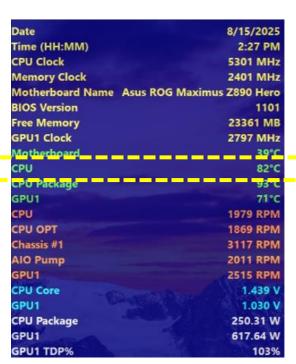
We used AIDA64 Extreme (stress FPU) and FurMark ROG Edition (resolution: 3840 x 2160) to push 100% load on the CPU and GPU for 30 minutes.



AIDA64 Extreme







FurMark Idle Full load



7. AIDA64 & FurMark Test

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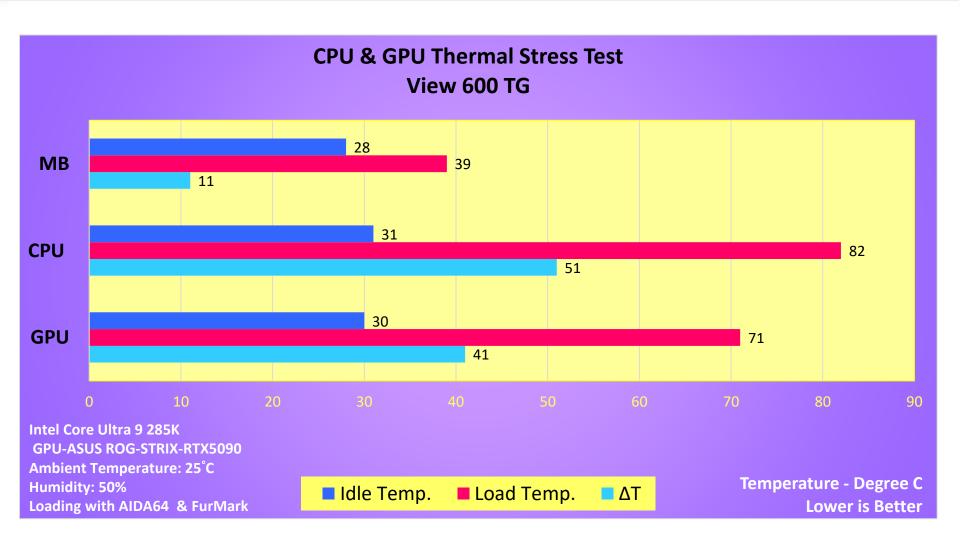




Idle Full load

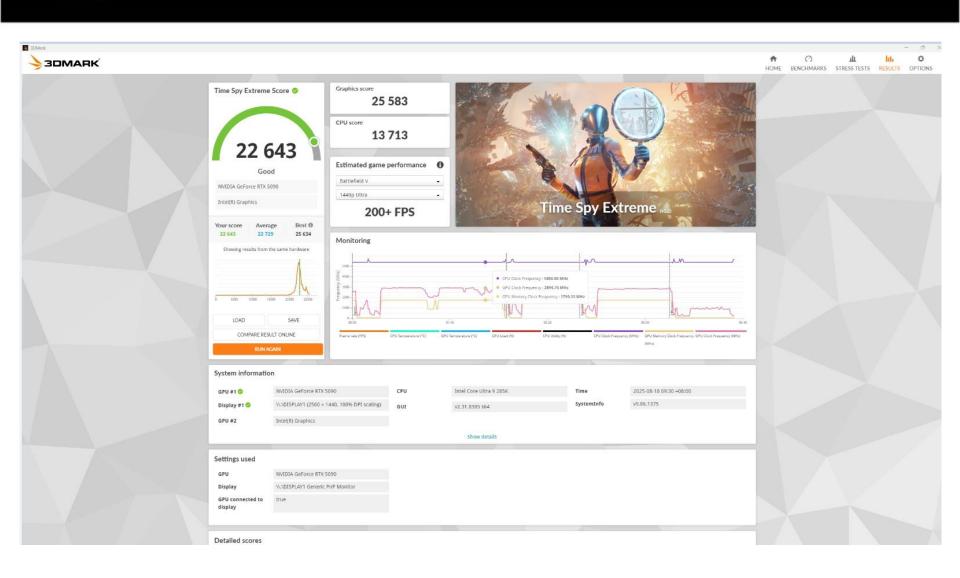


7. AIDA64 & FurMark Test





3. Graphics Performance Testing







9. Acoustic Sound Pressure Level Test

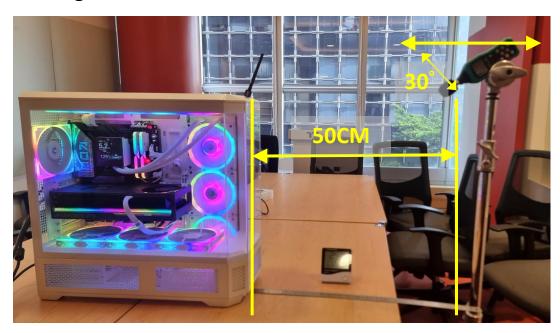
Test Environment: Thermaltake Taipei Office

Test Model: View 600 TG

Test Ambience: 25 °C (Temperature) / 59% R.H.(Relative Humidity)

Microphone position: 50 cm / in front of PC system

Background Noise: 35.1 dBA.





Microphone position

Test Ambience



9. Acoustic Sound Pressure Level Test

Fan Speed 550rpm – 36.2dBA

Fan Speed 560rpm – **36.4dBA**

Fan Speed 780rpm – 37.1dBA

Fan Speed 2000rpm – **52.6dBA**









Date	8/18/202
Time (HH:MM)	10:20 AN
CPU Clock	5401 MH
Memory Clock	2401 MH
TENERS TO A STATE OF THE STATE	Asus ROG Maximus Z890 Hero
BIOS Version	110
Free Memory	24278 MI
GPU1 Clock	405 MH
Motherboard	30°0
CPU	31°0
CPU Package	39°0
GPU1 CPU	551 RPN
	582 RPN
Chassis #1	1157 RPM
AlO Pump # ×	1616 RPN
GPU1	O RPN
CPU Core	1,412 \
GPU1	0.820 \
CPU Package	20.64 W
GPU1	25.00 V
CTT TELL Invent	
GPU1 TDP%	49

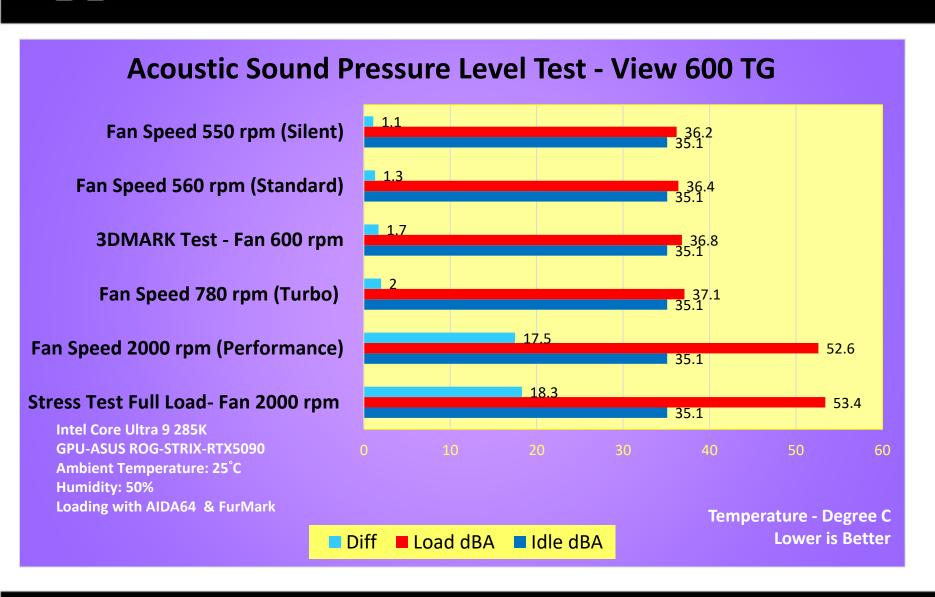
Date	8/18/2025
Time (HH:MM)	10:22 AM
CPU Clock	4901 MHz
Memory Clock	2400 MHz
Motherboard Name	Asus ROG Maximus Z890 Hero
BIOS Version	1101
Free Memory	24262 MB
GPU1 Clock	225 MHz
Motherboard	30°C
CPU	32°C
CPU Package	38°C
GPU1	34°C
CPU	562 RPM
CPU OPT	575 RPM
Chassis #1	1323 RPM
AlO Pump Ø ×	1638 RPM
GPU1	0 RPM
CPU Core	1.412 V
GPU1	0.800 V
CPU Package	20.24 W
GPU1	27.63 W
GPU1 TDP%	2%

Date	8/18/2025
Time (HH:MM)	10:24 AM
CPU Clock	4900 MHz
Memory Clock	2400 MHz
Motherboard Name	Asus ROG Maximus Z890 Hero
BIOS Version	1101
Free Memory	24219 MB
GPU1 Clock	397 MHz
Motherboard	30°C
CPU	31°C
CPU Package	37°C
GPU1	24°C
CPU	786 RPM
CPU OPT	755 RPM
Chassis #1	1708 RPM
AlO Pump Ø x	1732 RPM
GPU1	0 RPM
CPU Core	1.385 V
GPU1	0.810 V
CPU Package	18.35 W
GPU1	19.33 W
GPU1 TDP%	3%

Date	8/18/2025
Time (HH:MM)	2:30 PM
CPU Clock	5401 MHz
Memory Clock	2401 MHz
Motherboard Name Asus ROG Maximus	Z890 Hero
BIOS Version	1101
Free Memory	24806 MB
GPU1 Clock	225 MHz
Motherboard	27°C
CPU	28°C
CPU Package	33°C
GPU1	32°C
CPU	2039 RPN
CPU OPT	1899 RPM
Chassis #1	3333 RPM
AIO Pump	1985 RPM
GPU1	0 RPM
CPU Core	1.225 V
GPU1	0.800 V
CPU Package	16.90 W
GPU1	13.28 W
GPU1 TDP%	2%



9. Acoustic Sound Pressure Level Test

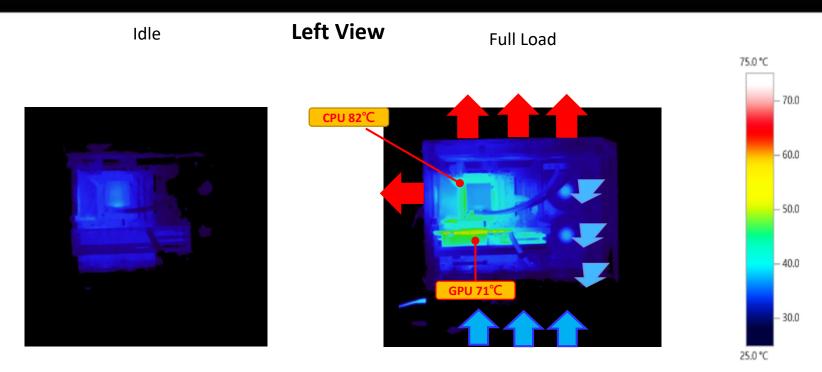




C. Conclusion



Conclusion



AIDA64 Extreme (stress FPU) and FurMark ROG Edition (resolution: 3840 x 2160) to push 100% load on the CPU and GPU for 30 minutes.

- -Intel Core Ultra 9 285K / CPU Temp. (Max) : 82°C (TDP 250W)
- -ASUS ROG Strix GeForce RTX® 5090 OC / GPU Temp. (Max): 71°C

Through the thermal image, we found that the internal heat was effectively directed to designated exhaustion vents, keeping the system operating at a cooler temperature. This finding validates how efficient The View 600 TG is regarding cooling performance.

thermaltake

Thank you!